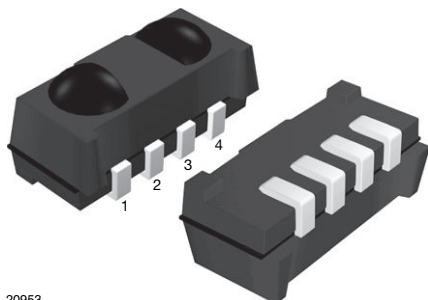


## IR Receiver Modules for Remote Control Systems



20953

### MECHANICAL DATA

#### Pinning:

1, 4 = GND, 2 =  $V_S$ , 3 = OUT

### FEATURES

- Very low supply current
- Photo detector and preamplifier in one package
- Internal filter for PCM frequency
- Supply voltage: 2.5 V to 5.5 V
- Improved immunity against ambient light
- Capable of side or top view
- Two lenses for high sensitivity and wide receiving angle
- Insensitive to supply voltage ripple and noise
- Narrow optical filter to reduce interference from plasma TV emissions
- Material categorization: For definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**  
**GREEN**  
(5-2008)

### DESCRIPTION

The TSOP752.., TSOP754.. series are two lens miniaturized receiver modules for infrared remote control systems. One PIN diode per lens and a preamplifier are assembled on a leadframe, the epoxy lens cap is designed as an IR filter.

The demodulated output signal can be directly connected to a digital input. The TSOP752.. is a legacy product for all common IR remote control data formats. The TSOP754.. is optimized to suppress almost all spurious pulses from energy saving fluorescent lamps. They may suppress some data signals.

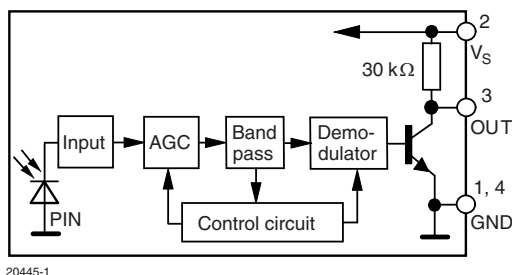
This component has not been qualified according to automotive specifications.

PARTS TABLE			
AGC		LEGACY, FOR LONG BURST REMOTE CONTROLS (AGC2)	RECOMMENDED FOR LONG BURST CODES (AGC4) <sup>(1)</sup>
Carrier frequency	30 kHz	TSOP75230	TSOP75430
	33 kHz	TSOP75233	TSOP75433
	36 kHz	TSOP75236	TSOP75436 <sup>(2)(3)(4)</sup>
	38 kHz	TSOP75238	TSOP75438 <sup>(5)(6)(9)</sup>
	40 kHz	TSOP75240	TSOP75440
	56 kHz	TSOP75256	TSOP75456 <sup>(7)(8)</sup>
Package	Pinning	1, 4 = GND, 2 = $V_S$ , 3 = OUT	
	Dimensions (mm)	3.2 H x 3.0 W x 6.8 L	
Mounting		SMD	
Application		Remote control	
Best remote control code		<sup>(2)</sup> RC-5 <sup>(3)</sup> RC-6 <sup>(4)</sup> Panasonic <sup>(5)</sup> NEC <sup>(6)</sup> Sharp <sup>(7)</sup> r-step <sup>(8)</sup> Thomson RCA <sup>(9)</sup> r-map	

#### Note

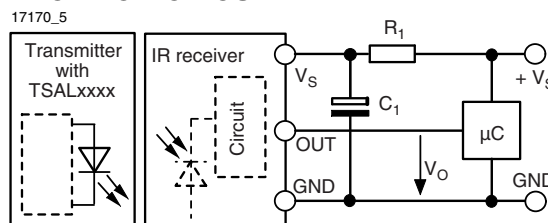
<sup>(1)</sup> We advise try AGC4 first if the burst length is unknown

### BLOCK DIAGRAM



20445-1

### APPLICATION CIRCUIT



$R_1$  and  $C_1$  are recommended for protection against EOS. Components should be in the range of  $33 \Omega < R_1 < 1 \text{ k}\Omega$ ,  $C_1 > 0.1 \mu\text{F}$ .

**ABSOLUTE MAXIMUM RATINGS**

PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Supply voltage		$V_S$	-0.3 to +6.0	V
Supply current		$I_S$	3	mA
Output voltage		$V_O$	-0.3 to ( $V_S + 0.3$ )	V
Output current		$I_O$	5	mA
Junction temperature		$T_j$	100	°C
Storage temperature range		$T_{stg}$	-25 to +85	°C
Operating temperature range		$T_{amb}$	-25 to +85	°C
Power consumption	$T_{amb} \leq 85\text{ °C}$	$P_{tot}$	10	mW

**Note**

- Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect the device reliability.

**ELECTRICAL AND OPTICAL CHARACTERISTICS** ( $T_{amb} = 25\text{ °C}$ , unless otherwise specified)

PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Supply voltage		$V_S$	2.5		5.5	V
Supply current	$E_v = 0$ , $V_S = 3.3\text{ V}$	$I_{SD}$	0.27	0.35	0.45	mA
	$E_v = 40\text{ klx}$ , sunlight	$I_{SH}$		0.45		mA
Transmission distance	$E_v = 0$ , test signal see fig. 1, IR diode TSAL6200, $I_F = 200\text{ mA}$	$d$		45		m
Output voltage low	$I_{OSL} = 0.5\text{ mA}$ , $E_e = 0.7\text{ mW/m}^2$ , test signal see fig. 1	$V_{OSL}$			100	mV
Minimum irradiance	Pulse width tolerance: $t_{pi} - 5/f_0 < t_{po} < t_{pi} + 6/f_0$ , test signal see fig. 1	$E_e\text{ min.}$		0.12	0.25	mW/m <sup>2</sup>
Maximum irradiance	$t_{pi} - 5/f_0 < t_{po} < t_{pi} + 6/f_0$ , test signal see fig. 1	$E_e\text{ max.}$	30			W/m <sup>2</sup>
Directivity	Angle of half transmission distance	$\phi_{1/2}$		$\pm 50$		deg

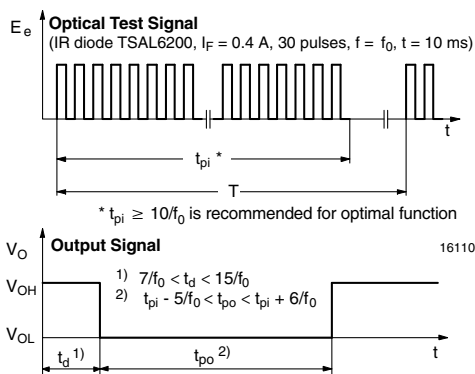
**TYPICAL CHARACTERISTICS** ( $T_{amb} = 25\text{ °C}$ , unless otherwise specified)

Fig. 1 - Output Active Low

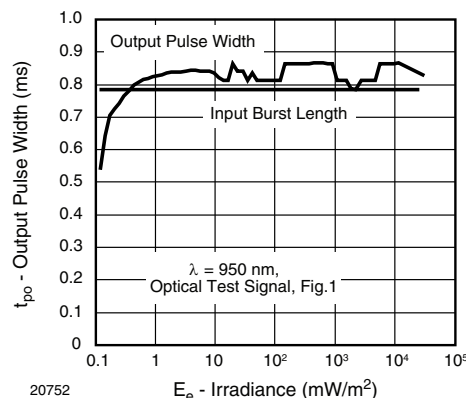


Fig. 2 - Pulse Length and Sensitivity in Dark Ambient

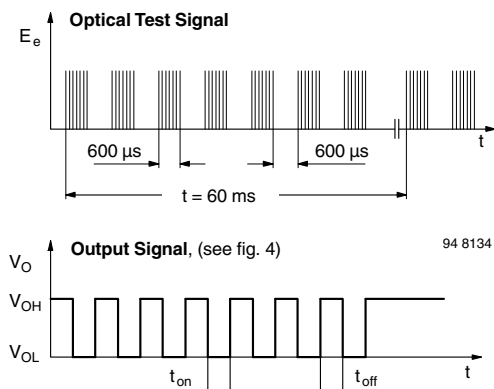


Fig. 3 - Output Function

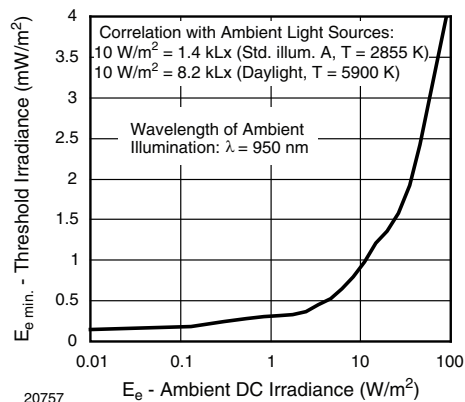


Fig. 6 - Sensitivity in Bright Ambient

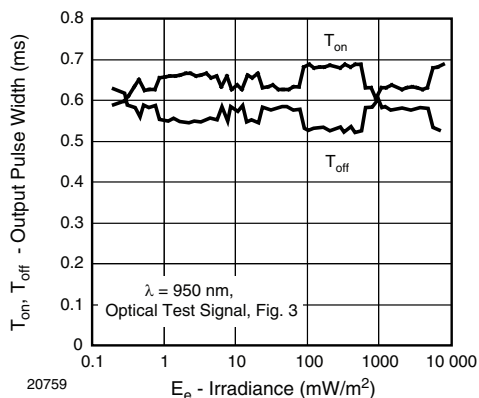


Fig. 4 - Output Pulse Diagram

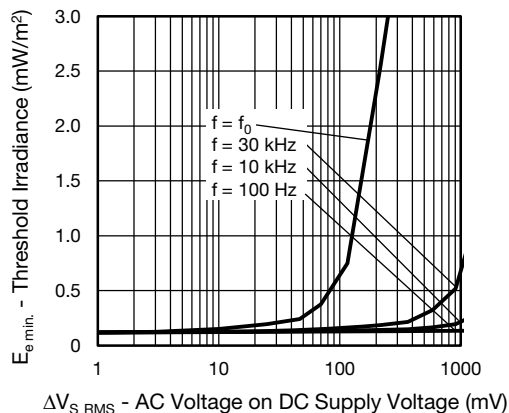


Fig. 7 - Sensitivity vs. Supply Voltage Disturbances

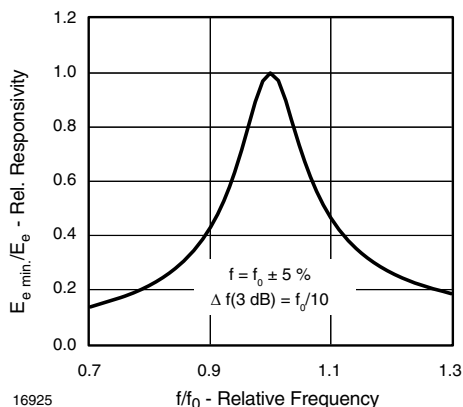


Fig. 5 - Frequency Dependence of Responsivity

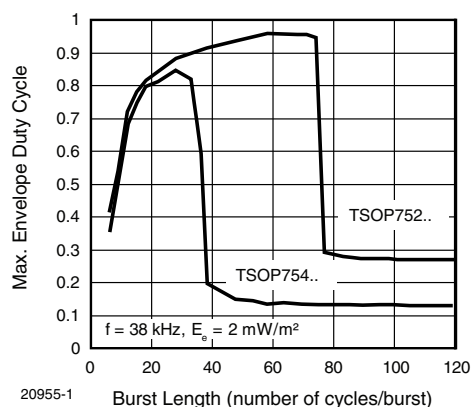


Fig. 8 - Max. Envelope Duty Cycle vs. Burst Length

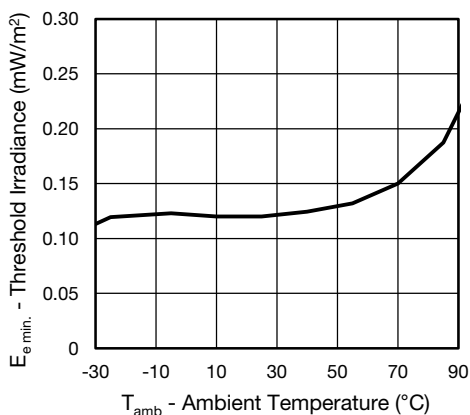


Fig. 9 - Sensitivity vs. Ambient Temperature

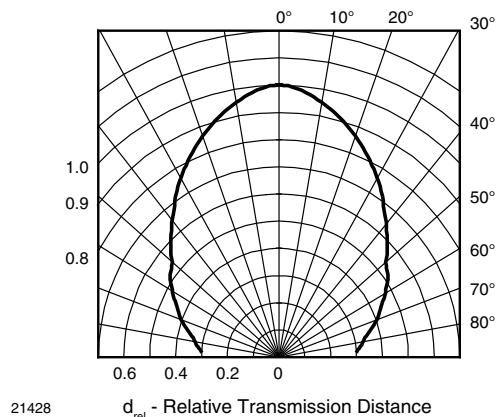


Fig. 12 - Vertical Directivity

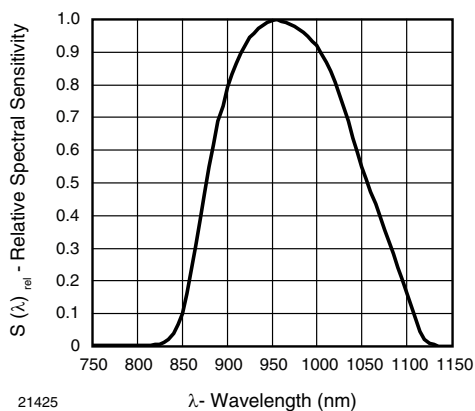


Fig. 10 - Relative Spectral Sensitivity vs. Wavelength

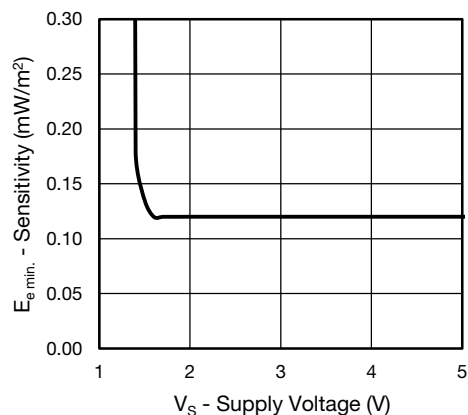


Fig. 13 - Sensitivity vs. Supply Voltage

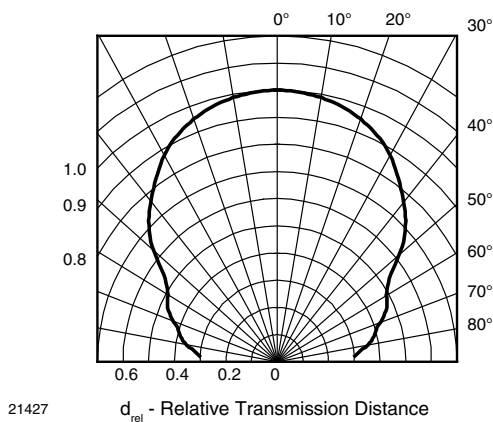


Fig. 11 - Horizontal Directivity

## SUITABLE DATA FORMAT

This series is designed to suppress spurious output pulses due to noise or disturbance signals. The devices can distinguish data signals from noise due to differences in frequency, burst length, and envelope duty cycle. The data signal should be close to the device's band-pass center frequency (e.g. 38 kHz) and fulfill the conditions in the table below.

When a data signal is applied to the product in the presence of a disturbance, the sensitivity of the receiver is automatically reduced by the AGC to insure that no spurious pulses are present at the receiver's output.

Some examples which are suppressed are:

- DC light (e.g. from tungsten bulbs sunlight)
- Continuous signals at any frequency
- Strongly or weakly modulated patterns from fluorescent lamps with electronic ballasts (see fig. 14 or fig. 15)

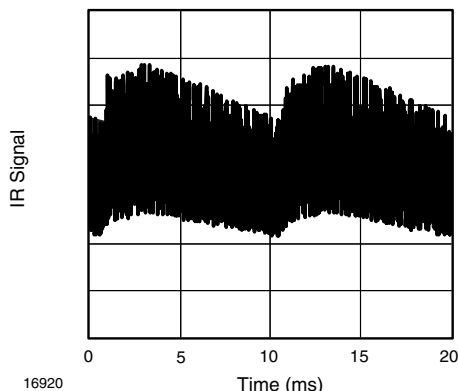


Fig. 14 - IR Disturbance from Fluorescent Lamp with Low Modulation

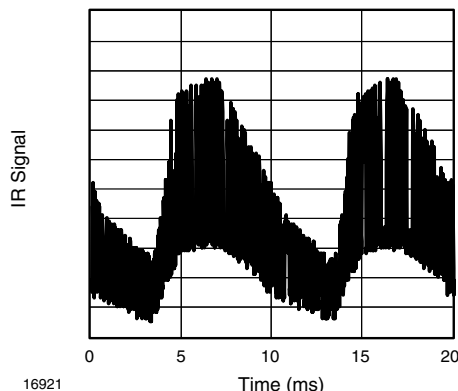


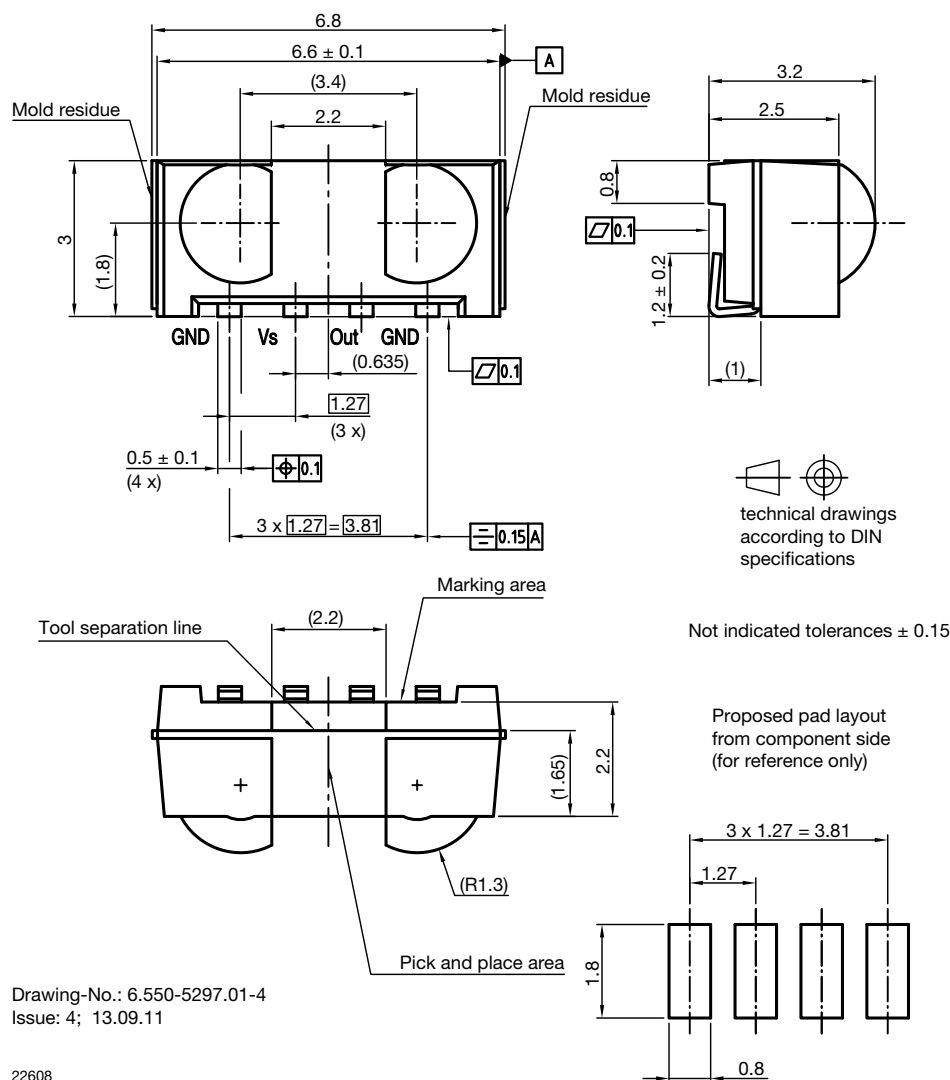
Fig. 15 - IR Disturbance from Fluorescent Lamp with High Modulation

	<b>TSOP752..</b>	<b>TSOP754..</b>
Minimum burst length	10 cycles/burst	10 cycles/burst
After each burst of length a minimum gap time is required of	10 to 70 cycles ≥ 10 cycles	10 to 35 cycles ≥ 10 cycles
For bursts greater than a minimum gap time in the data stream is needed of	70 cycles > 4 x burst length	35 cycles > 10 x burst length
Maximum number of continuous short bursts/second	1800	1500
Recommended for NEC code	yes	yes
Recommended for RC5/RC6 code	yes	yes
Recommended for Thomson 56 kHz code	yes	yes
Recommended for Mitsubishi code (38 kHz, preburst 8 ms, 16 bit)	yes	no
Recommended for Sharp code	yes	yes
Suppression of interference from fluorescent lamps	Most common disturbance patterns are suppressed	Even extreme disturbance patterns are suppressed

### Notes

- For data formats with short bursts please see the datasheet for TSOP753.., TSOP755..
- Example of compatible products for IR-codes:
  - TSOP75436: RC-5, RC-6, Panasonic
  - TSOP75438: NEC, Sharp, r-map
  - TSOP75456: r-step, Thomson RCA
- For SIRCS 15 and 20 bit, Sony 12 bit IR-codes, please see the datasheet for TSOP75S40F

### PACKAGE DIMENSIONS in millimeters



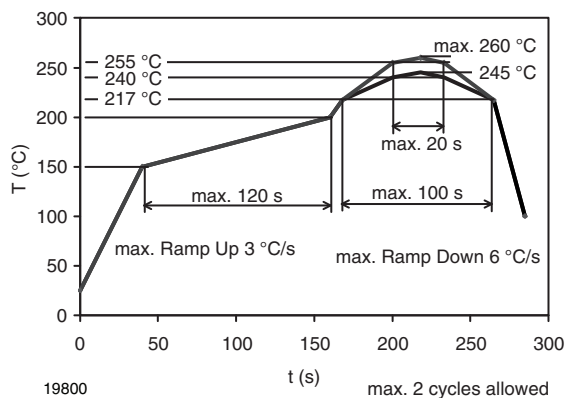
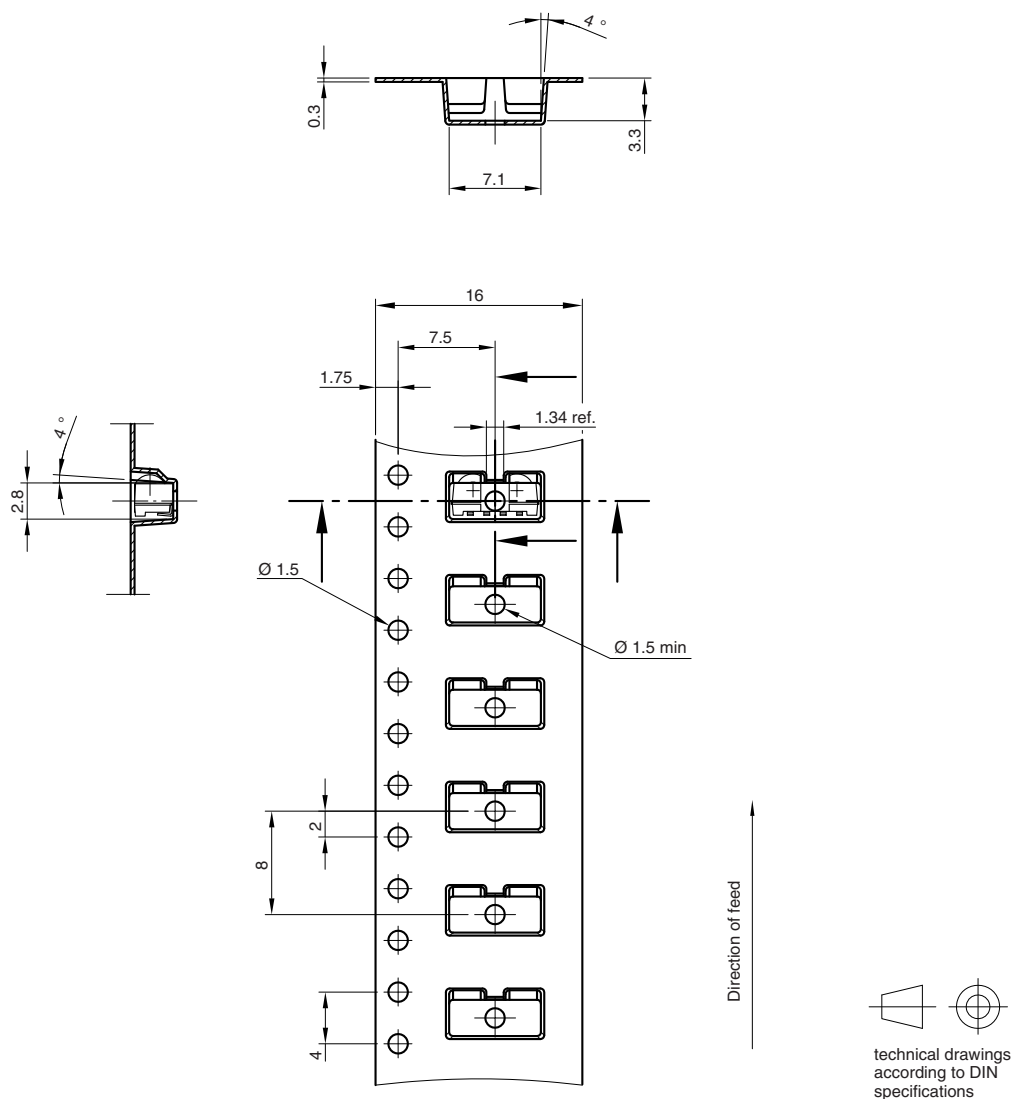
## ASSEMBLY INSTRUCTIONS

## Reflow Soldering

- Reflow soldering must be done within 72 h while stored under a max. temperature of 30 °C, 60 % RH after opening the dry pack envelope
- Set the furnace temperatures for pre-heating and heating in accordance with the reflow temperature profile as shown in the diagram. Exercise extreme care to keep the maximum temperature below 260 °C. The temperature shown in the profile means the temperature at the device surface. Since there is a temperature difference between the component and the circuit board, it should be verified that the temperature of the device is accurately being measured
- Handling after reflow should be done only after the work surface has been cooled off

## Manual Soldering

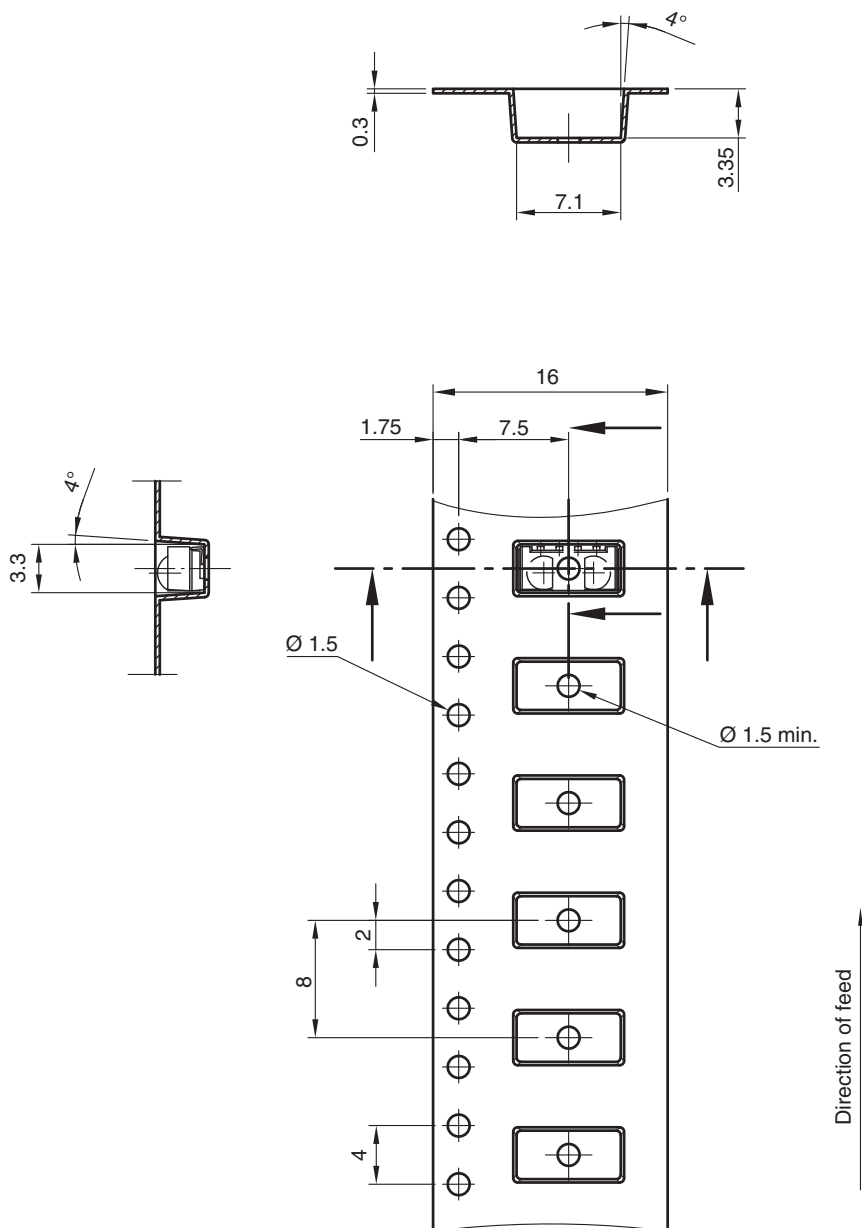
- Use a soldering iron of 25 W or less. Adjust the temperature of the soldering iron below 300 °C
- Finish soldering within 3 s
- Handle products only after the temperature has cooled off

**VISHAY LEAD (Pb)-FREE REFLOW SOLDER PROFILE**

**TAPING VERSION TSOP..TR DIMENSIONS in millimeters**


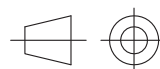
Drawing-No.: 9.700-5337.01-4  
Issue: 1; 16.10.08  
21577



**TAPING VERSION TSOP..TT DIMENSIONS** in millimeters

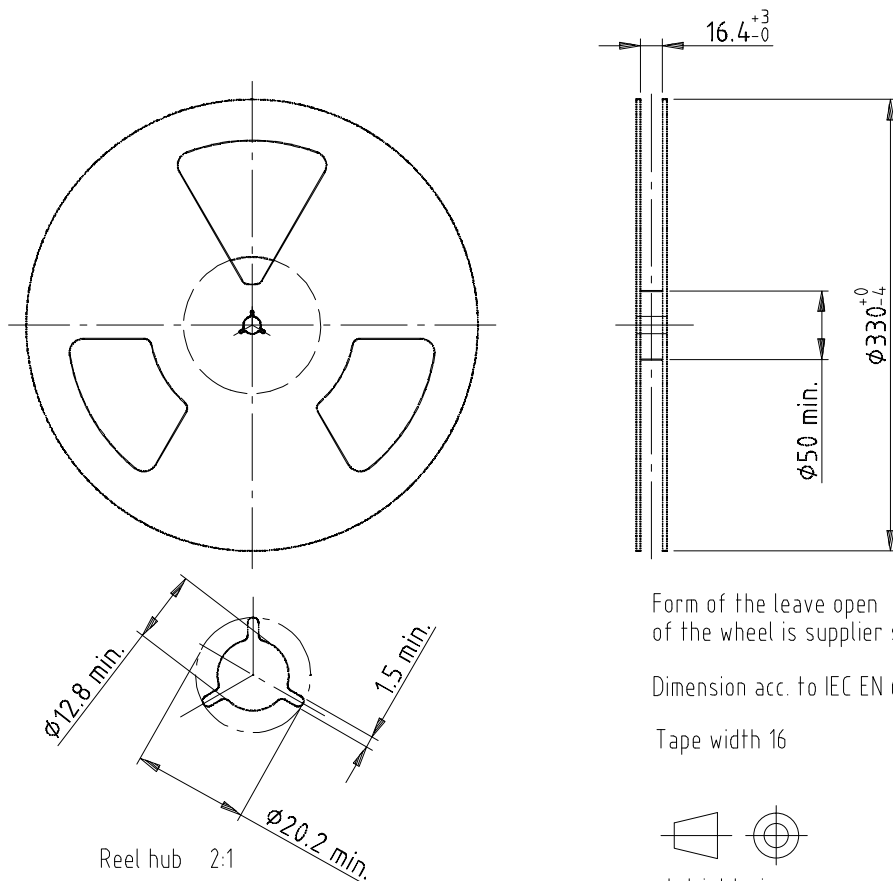


Drawing-No.: 9.700-5338.01-4  
Issue: 3; 09.06.09  
21578



technical drawings  
according to DIN  
specifications

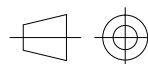


**REEL DIMENSIONS** in millimeters


Form of the leave open  
of the wheel is supplier specific.

Dimension acc. to IEC EN 60 286-3

Tape width 16

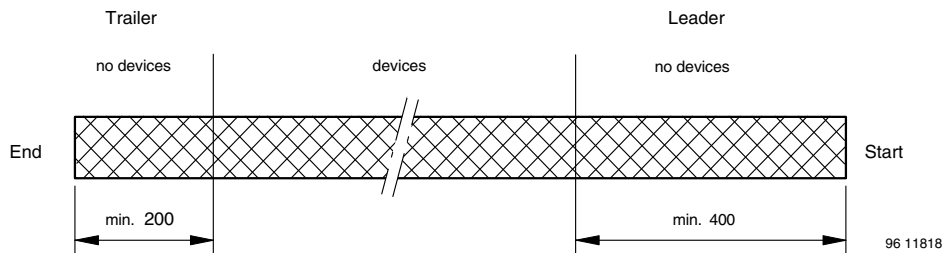


technical drawings  
according to DIN  
specifications

Drawing-No.: 9.800-5052.V2-4

Issue: 1; 07.05.02

16734

**LEADER AND TRAILER DIMENSIONS** in millimeters

**COVER TAPE PEEL STRENGTH**

According to DIN EN 60286-3

0.1 N to 1.3 N

300 ± 10 mm/min.

165° to 180° peel angle

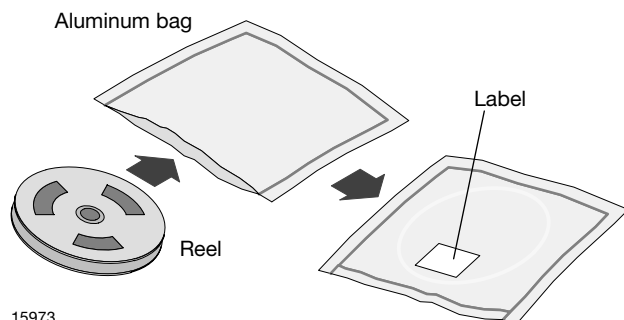
**LABEL**
**Standard bar code labels for finished goods**

The standard bar code labels are product labels and used for identification of goods. The finished goods are packed in final packing area. The standard packing units are labeled with standard bar code labels before transported as finished goods to warehouses. The labels are on each packing unit and contain Vishay Semiconductor GmbH specific data.

<b>VISHAY SEMICONDUCTOR GmbH STANDARD BAR CODE PRODUCT LABEL (finished goods)</b>		
PLAIN WRITING	ABBREVIATION	LENGTH
Item-description	-	18
Item-number	INO	8
Selection-code	SEL	3
LOT-/serial-number	BATCH	10
Data-code	COD	3 (YWW)
Plant-code	PTC	2
Quantity	QTY	8
Accepted by	ACC	-
Packed by	PCK	-
Mixed code indicator	MIXED CODE	-
Origin	xxxxxxx+	Company logo
Long bar code top	Type	Length
Item-number	N	8
Plant-code	N	2
Sequence-number	X	3
Quantity	N	8
Total length	-	21
Short bar code bottom	Type	Length
Selection-code	X	3
Data-code	N	3
Batch-number	X	10
Filter	-	1
Total length	-	17

## DRY PACKING

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



## FINAL PACKING

The sealed reel is packed into a cardboard box. A secondary cardboard box is used for shipping purposes.

## RECOMMENDED METHOD OF STORAGE

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

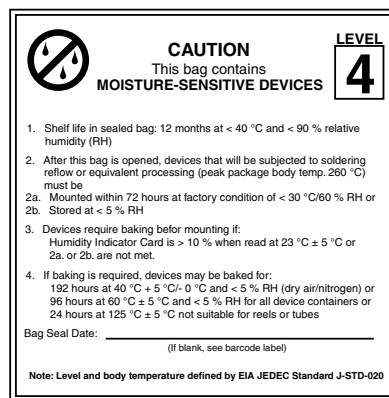
- Storage temperature 10 °C to 30 °C
- Storage humidity ≤ 60 % RH max.

After more than 72 h under these conditions moisture content will be too high for reflow soldering.

In case of moisture absorption, the devices will recover to the former condition by drying under the following condition:

- 192 h at 40 °C + 5 °C / - 0 °C and < 5 % RH (dry air/nitrogen) or
- 96 h at 60 °C + 5 °C and < 5 % RH for all device containers or
- 24 h at 125 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC® standard J-STD-020 level 4 label is included on all dry bags.



EIA JEDEC standard J-STD-020 level 4 label is included on all dry bags



## ESD PRECAUTION

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electro-static sensitive devices warning labels are on the packaging.

## VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.



22178



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**Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.**

**Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as Halogen-Free follow Halogen-Free requirements as per JEDEC JS709A standards. Please note that some Vishay documentation may still make reference to the IEC 61249-2-21 definition. We confirm that all the products identified as being compliant to IEC 61249-2-21 conform to JEDEC JS709A standards.**